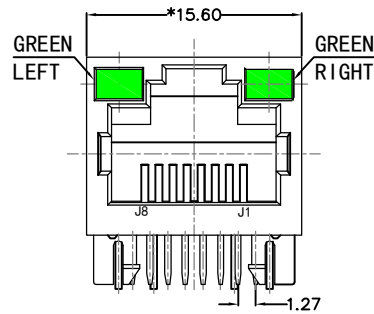
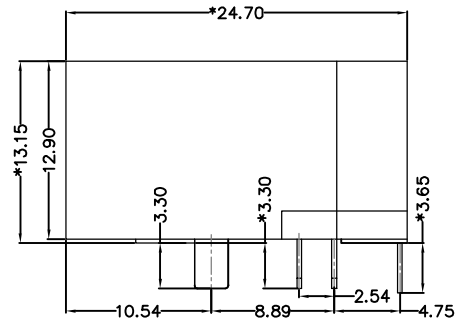


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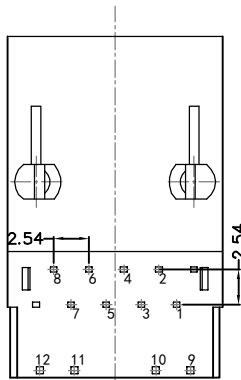
REV.	ECN / DESCRIPTION	BY	DATE
A0	NEW	MQ.Qu	2018.01.30



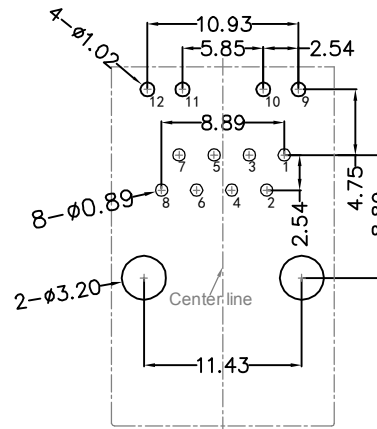
FRONT VIEW



RIGHT SIDE VIEW



BOTTOM VIEW



RECOMMENDED PCB LAYOUT  
VIEWED FROM COMPONENT SIDE

**MATERIAL:**

HOUSING : PBT,UL94V-0,BLACK.  
TERMINALS BRACKET: PBT,UL94V-0,BLACK.  
TERMINAL: PHOSPHOR BRONZE C5210,T=0.35MM,  
6U" GOLD PLATING ON CONTACT AREA.

**MECHANICAL:**

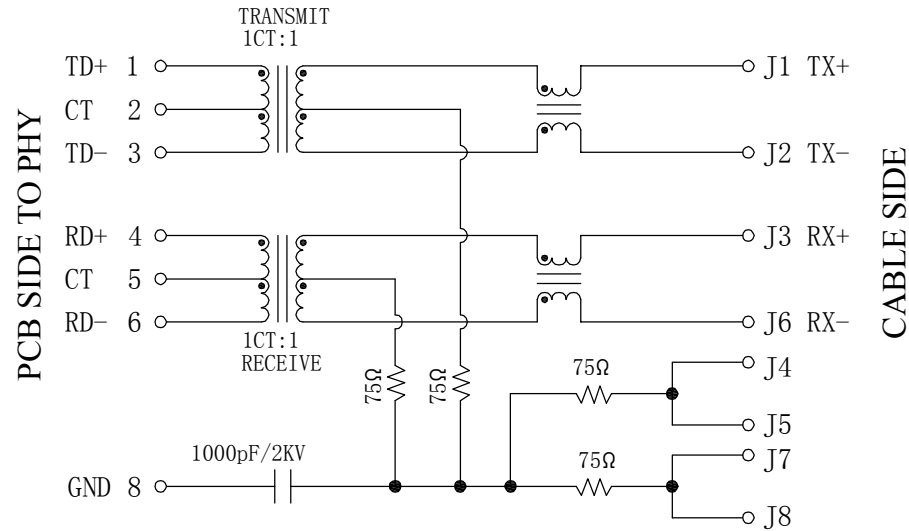
DURABILITY : 750 CYCLES MIN.  
MATING FORCE : 23N MAX.  
OPERATING TEMPERATURE: -40°C~+85°C.  
STORAGE TEMPERATURE: -40°C~+85°C.  
ALL CRITICAL DIMENSIONS WITH "\*"

CELION SAS

TITLE: TAB-UP 1X1 100BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
	PART NO.: 311B083JB3A4D	SACLE 1:1	REV A0	$x \pm 0.35$ $x^\circ \pm 3.0^\circ$	CHECKED BY: TW.XU
	REMARK:	SHEET 1/3		$.xx \pm 0.25$ $.xxx \pm 0.10$	$.xx^\circ \pm 1.5^\circ$ $.xxx^\circ \pm 1.0^\circ$

REACH & RoHS  
COMPLIANT

REV.	ECN / DESCRIPTION	BY	DATE
A0	NEW	MQ.Qu	2018.01.30

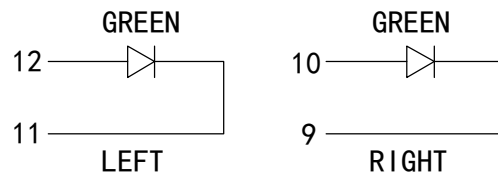


**Electrical:**

- Turn ratio: 1~3: J1~J2=1CT:1CT(±2%).  
4~6: J3~J6=1CT:1CT(±2%).
- OCL: 350uH Min. at 100KHz 100mV 8mA DC.
- Insertion Loss: -1.0 dB Max 1~100MHz.
- Return loss: -20dB Min 1~10MHz;  
-16dB Min 10~30MHz.  
-12dB Min 30~60MHz.  
-10dB Min 60~80MHz.
- Cross talk: -40dB Min 1~30MHz;  
-35dB Min 30~60MHz;  
-30dB Min 60~100MHz;
- CMR: -30dB Min 1~100MHz;
- Hi-Pot: 1500V AC & 2250V DC  
6S 1mA PRI TO SEC

**LED Specification**

Standard LED Color	LED Wavelength	Foward(A)	Foward(V)
Green	568nm	20mA	1.85-2.45V



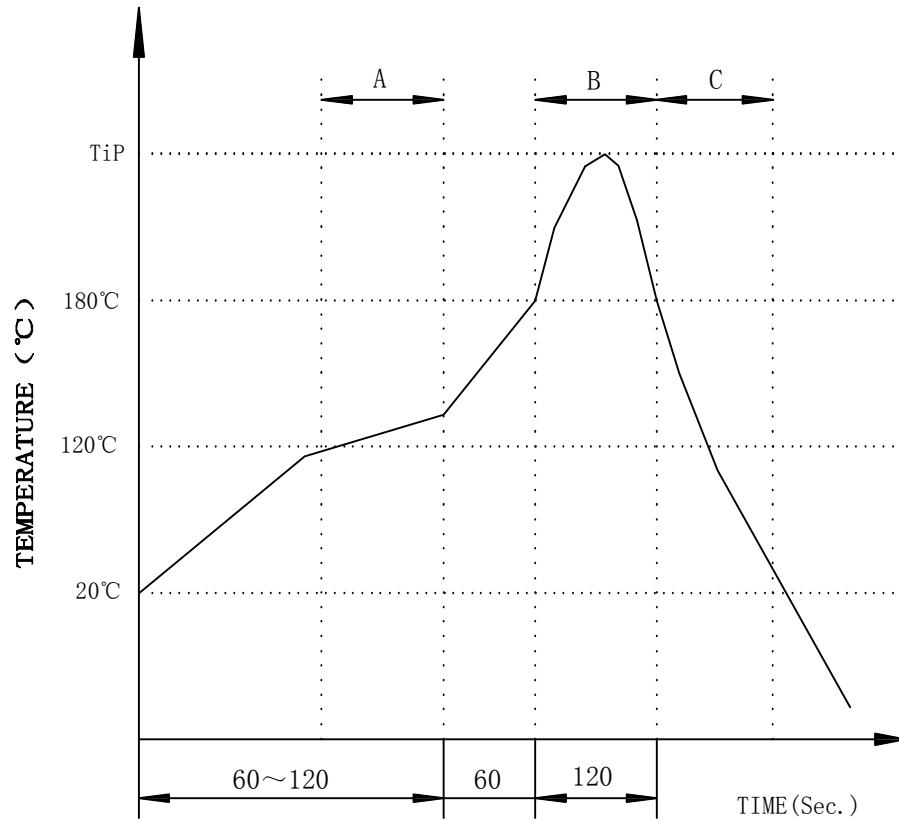
CELION SAS

TITLE: TAB-UP 1X1 100BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
PART NO.: 311B083JB3A4D	SACLE 1:1	REV A0	x±0.35 .x±0.30	x°±3.0° .x°±2.0°	CHECKED BY: TW.XU
REMARK:	SHEET 2/3		.xx±0.25 .xxx±0.10	.xx°±1.5° .xxx°±1.0°	DESIGND BY: MQ.QU

REACH & RoHS  
COMPLIANT

# PROFILE OF WAVE SOLDER

REV.	ECN / DESCRIPTION	BY	DATE
A0	NEW	MQ.Qu	2018.01.30



A.Preheating B.Soldering C.Gradual Cooling  
 Tip temperature:260±5°C.  
 Tip temperature time:5Sec Max.  
 Tip melting point of Sn96.5/Ag3/Cu0.5:217°C.

Remarks: after wave soldering, the plastic  
 positioning columns of the product which under the  
 PCB will be slightly melted, but it won't affect its  
 function.

CELION SAS	TITLE: TAB-UP 1X1 100BASE	SIZE A4	UNITS MM[INCH]	GENERAL TOLERANCES UNLESS SPECIFIED		APPROVED BY: JP.Gong
	PART NO.: 311B083JB3A4D	SACLE 1:1	REV A0	x±0.35	x°±3.0°	CHECKED BY: TW.XU
	REMARK:	SHEET 3/3		.xx±0.25	.xx°±1.5°	DESIGND BY: MQ.QU
				.xxx±0.10	.xxx°±1.0°	